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Dated: September 8, 2009  
Electronic Signature for James E. Armstrong, IV: /James E. Armstrong, IV/

Docket No.: 80039(302720)  
(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
Takuya Kodama et al.

Application No.: 10/568,277

Confirmation No.: 3107

Filed: November 9, 2006

Art Unit: 1796

For: PHENOLIC RESIN MOLDING MATERIAL  
AND RESIN SLIDING PART

Examiner: T. H. Yoon

### AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir/Madam:

### **INTRODUCTORY COMMENTS**

In response to the Office Action dated June 8, 2009, rejecting claims 1-4, 10 and 11, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 4 of this paper.